捷多邦,专业PCB打样工厂,24小时加急出货



# H5N5006FM

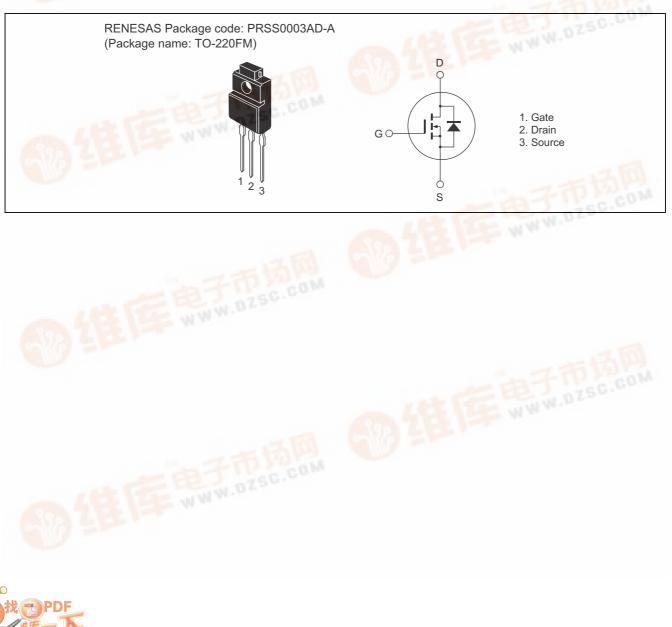
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1114-0200 (Previous: ADE-208-1112) Rev.2.00 Sep 07, 2005

## Features

- Low on-resistance:  $R_{DS (on)} = 2.5 \Omega$  typ.
- Low leakage current:  $I_{DSS} = 1 \ \mu A \ max \ (at \ V_{DS} = 500 \ V)$
- High speed switching:  $t_f = 15 \text{ ns}$  typ (at  $V_{GS} = 10 \text{ V}$ ,  $V_{DD} = 250 \text{ V}$ ,  $I_D = 1.5 \text{ A}$ )
- Low gate charge: Qg = 14 nC typ (at  $V_{DD} = 400 \text{ V}$ ,  $V_{GS} = 10 \text{ V}$ ,  $I_D = 3 \text{ A}$ )
- Avalanche ratings

# Outline



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# **Absolute Maximum Ratings**

			(Ta = 25°C)
ltem	Symbol	Value	Unit
Drain to source voltage	V <sub>DSS</sub>	500	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	ID	3	А
Drain peak current	I <sub>D (pulse)</sub> Note 1	12	А
Body-drain diode reverse drain current	I <sub>DR</sub>	3	А
Body-drain diode reverse drain peak current	I <sub>DR (pulse)</sub> Note 1	12	А
Avalanche current	AP Note 3	3	А
Channel dissipation	Pch Note 2	25	W
Channel to case thermal Impedance	θ ch-c	5.0	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at Tc = 25°C

3. Tch  $\leq 150^{\circ}$ C

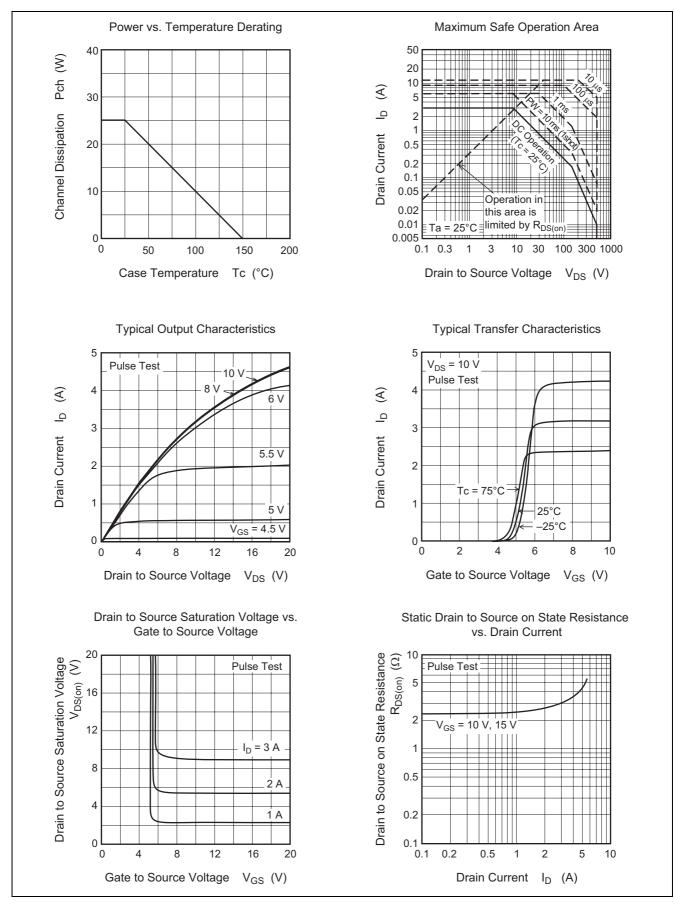
# **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	500	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I <sub>GSS</sub>		—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>		_	1	μΑ	$V_{DS} = 500 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS (off)</sub>	3.0		4.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R <sub>DS (on)</sub>	_	2.5	3.0	Ω	$I_D = 1.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note 4}$
Forward transfer admittance	y <sub>fs</sub>	1.5	2.5	—	S	$I_D = 1.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note 4}$
Input capacitance	Ciss	_	365	_	pF	V <sub>DS</sub> = 25 V
Output capacitance	Coss	_	35	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	8	—	pF	f = 1 MHz
Turn-on delay time	t <sub>d (on)</sub>	_	20	—	ns	I <sub>D</sub> = 1.5 A
Rise time	tr	_	12	—	ns	V <sub>GS</sub> = 10 V
Turn-off delay time	t <sub>d (off)</sub>		48	—	ns	R <sub>L</sub> = 167 Ω
Fall time	t <sub>f</sub>		15	—	ns	Rg = 10 Ω
Total gate charge	Qg		14		nC	V <sub>DD</sub> = 400 V
Gate to source charge	Qgs		2	—	nC	V <sub>GS</sub> = 10 V
Gate to drain charge	Qgd		8		nC	I <sub>D</sub> = 3 A
Body-drain diode forward voltage	V <sub>DF</sub>		0.85	1.3	V	$I_F = 3 A, V_{GS} = 0$
Body-drain diode reverse recovery time	t <sub>rr</sub>		270	—	ns	$I_F = 3 A, V_{GS} = 0$
Body-drain diode reverse recovery charge	Qrr		0.8	_	μC	di <sub>F</sub> /dt = 100 A/µs

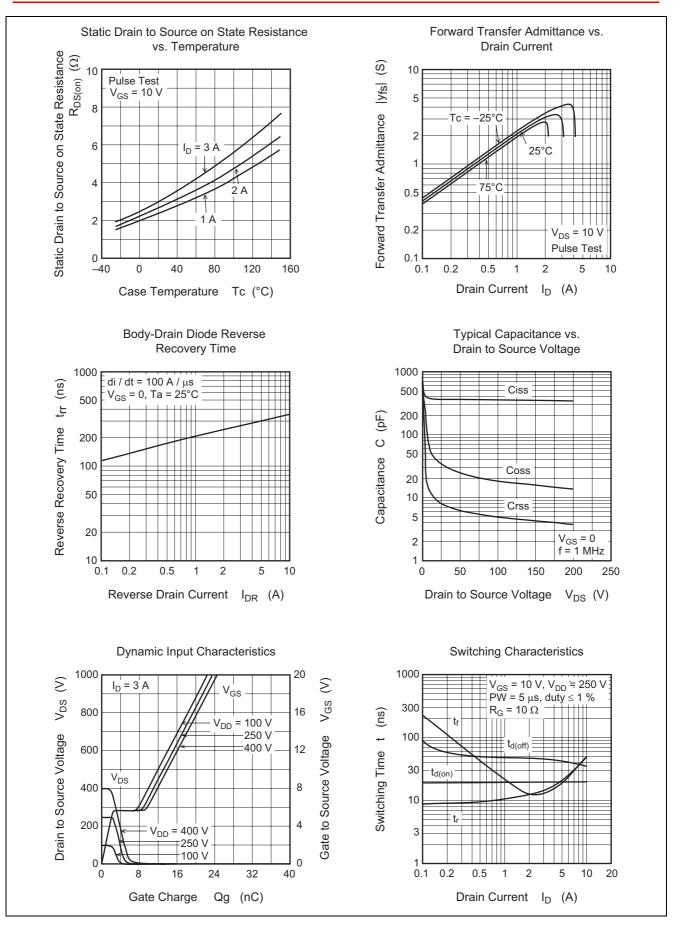
Note: 4. Pulse test

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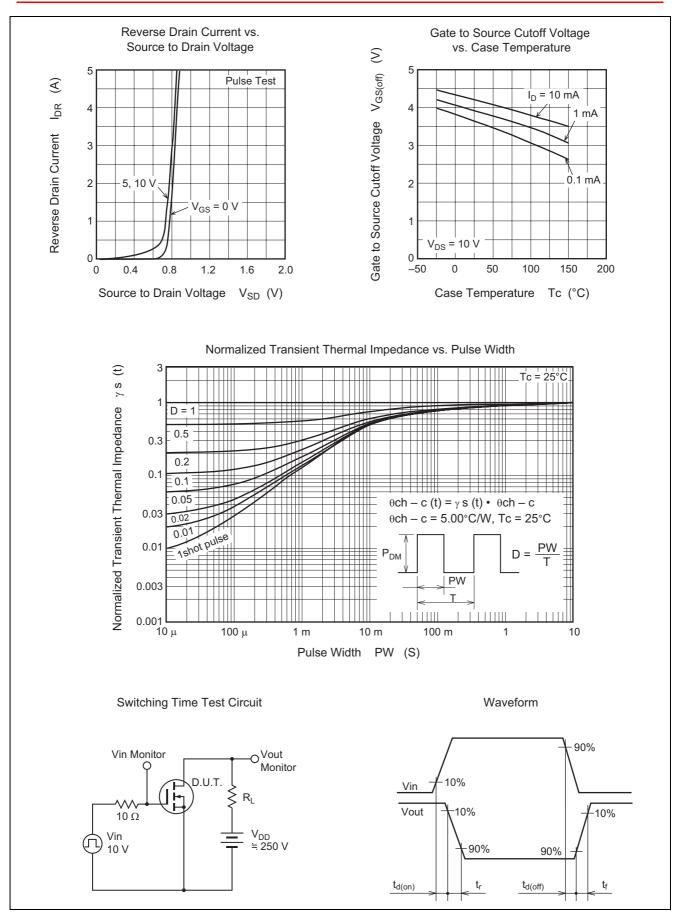
### **Main Characteristics**



### H5N5006FM

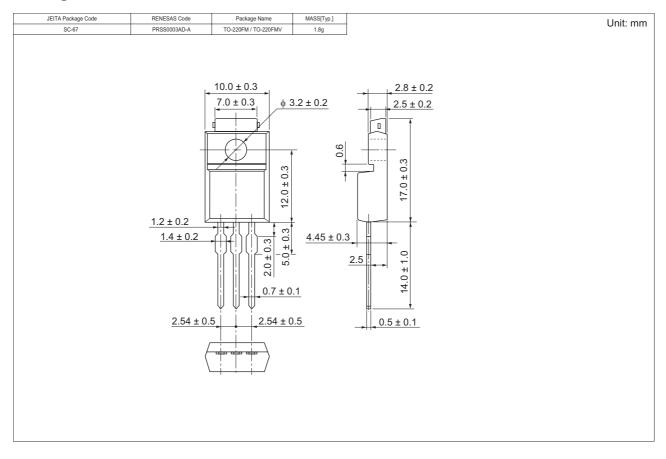


### H5N5006FM



### H5N5006FM

## **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container		
H5N5006FM-E	500 pcs	Box (Sack)		
Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of				

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